Developer for AR E-Beam Resists

AR 600-50, -51, 600-546, -548, -549, 600-55, -56 developer

For the development of e-beam resists films

Characterisation

Droportios

AR-P 6200

- ultrapure, ultra-filtered (0.2 μm) solvent mixtures
- storage at 10-22 °C for 6 month

Properties		safer solvent			optimally suited	suited	
AR resist / developer		600-50	AR 600-51	1	AR 600-55	AR 600-56	
Fields of application/conditions		dip, puddle, spray development at 21-23 °C ± 1 °C					
Main component(s)		/propanol / oyl alcohol	butoxyethox ethanol	ху	methyl isobutyl ketone (MIBK)	methyl isobutyl ketone (MIBK)	
Properties					strong developer	weaker developer	
Density at 20 °C (g/cm3)	0	.871	0.972		0.792	0.788	
Refractive index at 20 °C	1	.395	1.430		1.384	1.381	
Water content max. (%)		0.1	15		0.1	0.1	
Flash point (°C)		21	85		12	12	
AR-P 617	2-3	3 min	-		3 min	3 min	
AR-P 630 - 670 series		-	-		1-3 min	1-3 min	
AR-P 6500		-	1 h		-	-	
AR resist / developer AR 600-54		00-546	AR 600-54	-8	AR 600-549		
Fields of application/conditions		dip, puddle, spray development at 21-23 °C ± 1 °C					
Main component(s)	amyl	acetate	diethyl ketone diethyl malona		diethyl malonate / anisole		
Properties	weaker	developer	strong develop	oer	moderate developer		
Density at 20 °C (g/cm3)	0	.876	0.917		1.053		
Refractive index at 20 °C	1	402	1.401		1.417		
Water content max. (%)		0.1	0.1		0.1		
Flash point (°C)		41	22		85		
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Information on developer processing

The choice of the developer strongly influences the development rate, the sensitivity and the profile of the resist structures. Coated and exposed substrates are treated with developers which are suitable for the respective process (puddle, spray, immersion bath) at a temperature of 21-23 $^{\circ}$ C kept as constant as possible. The required development time depends in each case on the resist film thickness. Films with a thickness of less than 0.2 μ m can for example be completely developed after 30 s. The development process can be slowed down for AR 600-50, -55 and -56 by adding 10-20 $^{\circ}$ 6 of the stopper AR 600-60.

1 min

1 min

1 min

Weaker developers like AR 600-56 and AR 600-546 provide a higher resolution without dark erosion, while a significantly higher sensitivity with at the same time higher dark erosion can be obtained with developers AR 600-55 and AR 600-548. If CSAR 62 is processed with developer AR 600-548 at a development temperature of about 0 $^{\circ}$ C, even after 10 minutes no erosion is observed at the prolonged development time. Substrates have to be rinsed immediately after development for 30 seconds with stopper and are subsequently dried.